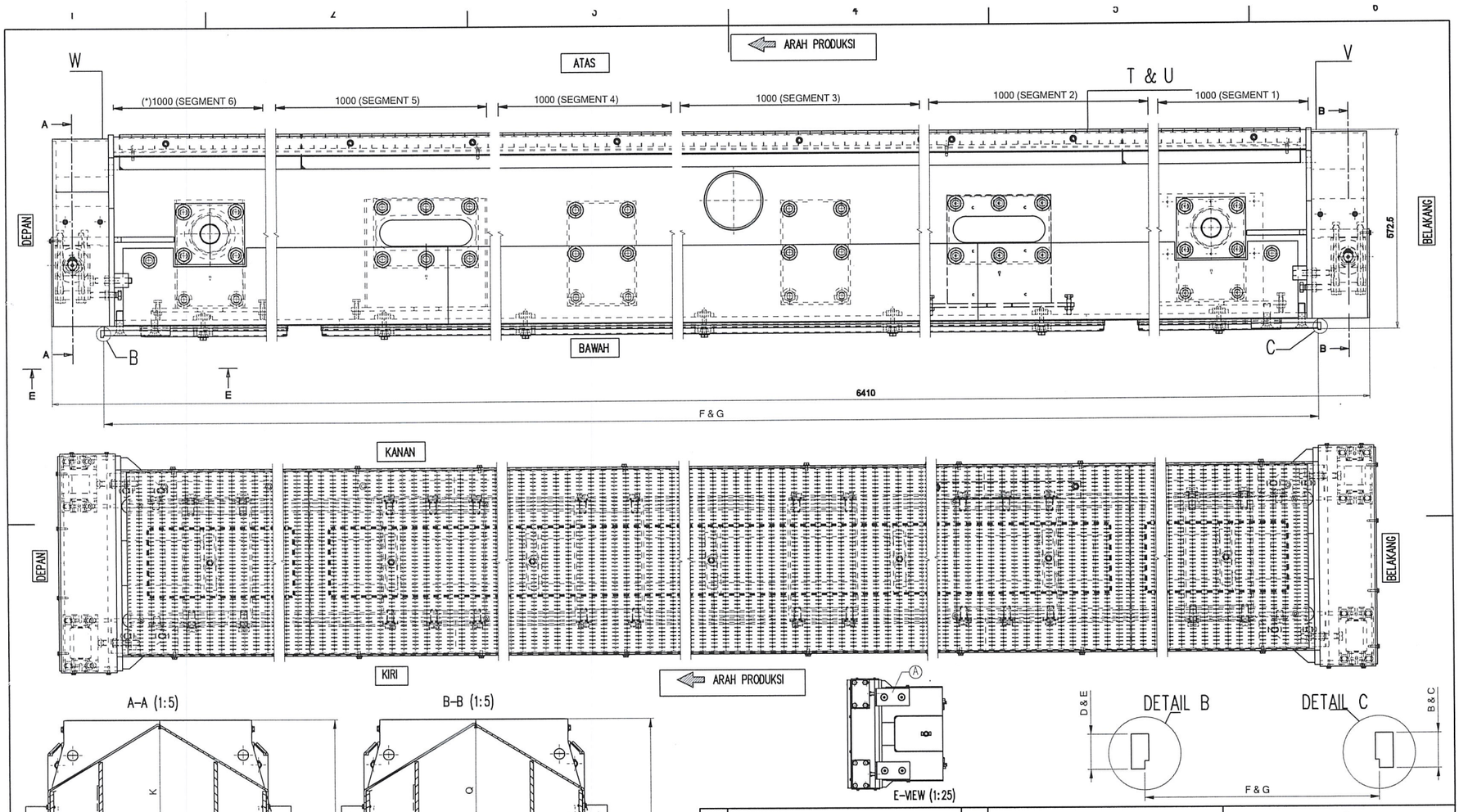

POS	DESCRIPTION	QTY	MATERIAL	REMARKS

FILE DIR: _ SCALE: 1:15 DIM: mm ASSY NO.

DIM: mm	NAME	DATE	SIGN
DRAWN	ENDEN	7/APR/20	
DESIGN	NAIM		
CHECK	SIGIT		
APRV	YESSIKO		

MECHANICAL ENGINEERING SECTION

TITLE CUTTING PLAN - CUTTING BOARD

STANDARISASI CUTTING BOARD

( )= GENERAL TOLERANSI ±0.2% x DIMENSION

REFF DWG NO.

SCG PT SCG LIGHTWEIGHT CONCRETE INDONESIA A4 – REV NO. —

** INCOMING PART WILL BE CHECK. IT WILL RETURN IF NOT PASS **

POLISHING	GRINDING	NORMAL MACHINING (SMOOTH SURFACE)	NORMAL MACHINING (ROUGH SURFACE)
▽▽▽▽	▽▽▽	▽▽	▽

ISOMETRIC VIEW
*NB= ESTIMATION WEIGHT: 0.9 KG

CHECK LIST					DEVICE LINK	
NO	PART	PARAMETER	STANDARD	EXISTING	DEVICE	PARAMETER
A	Base plate	Kondisi Plat	Tidak aus			
B	Kuku Cutting Board	Belakang Kanan	18.3 mm			
C		Belakang kiri	18.3 mm			
D		Depan Kanan	18.3 mm			
E		Depan Kiri	18.3 mm			
F		Jarak sisi dalam kanan kuku cuting board (depan-belakang)	6120 mm			
G		Jarak sisi dalam kiri kuku cuting board (depan-belakang)	6120 mm			
H		Diameter supporting roll cutting board (kanan)	60±2mm			
I	Roller cutting board (Belakang)	Diameter supporting roll cutting board (kiri)	60±2mm			
J		Jarak roll ke permukaan atas cutting board (kanan)	410±1mm			
K		Jarak roll ke permukaan atas cutting board (kiri)	413±1mm			
L		Jarak roll ke plate bawah (kanan)	45±1mm			
M		Jarak roll ke plate bawah (kiri)	45±1mm			
N	Roller cutting board (Depan)	Diameter supporting roll cutting board (kanan)	60±2mm			
O		Diameter supporting roll cutting board (kiri)	60±2mm			
P		Jarak roll ke permukaan atas cutting board (kanan)	410±1mm			
Q		Jarak roll ke permukaan atas cutting board (kiri)	413±1mm			
R		Jarak roll ke plate bawah (kanan)	45±1mm			
S		Jarak roll ke plate bawah (kiri)	45±1mm			
T	Screen	Kerataan permukaan(*)	Sama (sejajar)			
U		Kondisi screen	Tidak sobek			
V	Siku Cutting board	Belakang	Flat			
W		Depan	Flat			
X	Vacuum Box	Kondisi plat cover	Tidak penyok			
Y		Sambungan plat	Tidak retak			

(*) SEGMEN NOMER 6 CUTTING BOARD 1-3 LEVEL +3mm